

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): TANABE, et al.

Application No.: TBD

Filed: February 10, 2004

For: METHOD FOR FABRICATING SEMICONDUCTOR  
INTEGRATED CIRCUIT DEVICE

Expected  
Group: 2829

Expected  
Examiner: L. Kilday

CLAIM FOR PRIORITY

Mail Stop Patent Application  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

February 10, 2004

Sir:

Pursuant to the requirements of 35 U.S.C. § 119 and 37 CFR § 1.55,  
Applicants respectfully claim priority based on Japanese Patent Application  
Serial No. 9/50781, filed in Japan on March 5, 1997.

As indicated in the Notification of Acceptance of Application Under  
35 USC 371 and 37 CFR 1.494 or 1.495 mailed November 10, 1999 in Serial  
No. 09/380,646, filed September 7, 1999, the Priority Document for the above-  
identified Japanese Patent Application was received in prior application  
Serial No. 09/380,646.

Respectfully submitted,

ANTONELLI, TERRY, STOUT & KRAUS, LLP

  
William I. Solomon  
Registration No. 28,565

WIS/sjg